

486x-series

Description

The 486x [where x = 0, 5, 8] series of Sn63/Pb37 Leaded Solder is an electronic grade solder wire. It uses the eutectic tin-to-lead alloy ratio, which is complemented with a no clean, synthetically refined, splatter-proof, resin flux core. The 486x series meets J-STD-004 and J-STD-006 specifications. It is one of the easiest solders to work with because it offers a low-melting temperature with a sharp melting/solidification point, which results in robust and reliable joints that are highly resistant to whisker formation.

The 486x leaded solders achieve a consistent solder and flux percentage through a state-of-the-art, extrusion, wire-drawing machine. This machine continually monitors the wire to prevent voids and ensure consistency, providing a top-grade solder wire.

Benefits & Features

- **Eutectic alloy** (liquidus = solidus temperature)
- Spreads like rosin activated flux
- · Virtually non-splattering
- Non-corrosive
- Non-conductive
- Halide free

COMPLIANCE

- ✓ Dobb Frank (<u>DRC conflict free</u>)
- ✓ REACH (compliant)
- * RoHS (non-compliant)

Wire Sizes Availability

Cat No.	Std. Wire Gauge	Diameter		Packaging	Sizes
4860 4865	21 21	0.81 mm 0.81 mm	0.032 in 0.032 in	Pocket Pack Spool	0.6 oz ½ or 1 lb
4866	19	1.01 mm	0.040 in	Spool	½ lb

General Flux Parameters

Property	Value
Residue Removal Flux Percentage Flux feature Shelf life	Not required 2.2% Wets and spreads like a RA type flux and virtually non-splattering. 5 y

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Date: 09 May 2017 / Ver. 1.02



486x-series

Flux Core Properties

The synthetically refined resin wets and spreads like a RA flux. This no clean flux is virtually non-splattering. It gives rise to a hard, non-conductive and non-corrosive residue.

Physical Properties	Method	Value
Flux Classification	J-STD-004	REL0
	EN29454-1	Type 1.1.3
Flux Type		Resin
Flux Activity		Low
Halides %(wt)		<0.05%
Solid Flux Color	Visual	Lightly opaque
Softening Point of Flux Extract		24 °C [75 °F]
Acid Number (mgKOH/g sample)	IPC-TM-650 2.3.13	190-210
Copper Mirror	IPC-TM-650 2.3.32	No removal
Silver Chromate—Chlorides + Bromides	IPC-TM-650 2.3.33	Pass
Solder Spread	IPC-TM-650 2.4.46	130 mm ²
Flux Residue Dryness	IPC-TM-650 2.4.47	Pass
Spitting of Flux-Cored Wire Solder	IPC-TM-650 2.4.48	0.30%
Corrosion Test	IPC-TM-650 2.6.15	Non-corrosive
Surface Insulation Resistance (SIR)	IPC-TM-650 2.6.3.3	$2.3 \times 10^{11} \Omega$
Bellcore (Telecordia)	Bellcore GR-78-CORE 13.1.3	$6.1 \times 10^{11} \Omega$
Electromigration	Bellcore GR-78-CORE 13.1.4	Pass
Post Reflow Residue	TGA Analysis	55%
Cleaning Requirements	_	Optional

Sn63/Pb37 Alloy Typical Literature Properties

Physical Properties	Value a)
Color	Silvery-white metal
Density @26 °C [78 °F]	8.40 g/cm ³
Tensile Strength Elongation	54 N/mm ² [7 800 lb/in ²] 37%
Hardness	14 HB
Shear Strength	37 N/mm ² [5 400 lb/in ²]
Electrical Properties	Value
Volume Resistivity	14.5 μΩ·cm
Electrical Conductivity ^{b)}	11.9% IACS

a) $N/mm^2 = mPa$; $Ib/in^2 = psi$;

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b) International Annealed Copper Standard: 100% give 5.8×10^7 S/m.



486x-series

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Thermal Properties	Value
Melting Point, Solidus	183 °C [361 °F]
Melting Point, Liquidus	183 °C [361 °F]
Tip Temperature Upper Limit	Do not exceed 260 °C [500 °F]
Coefficient of Thermal Expansion (CTE) c)	24.7 ppm/°C
Thermal Conductivity	50 W/(m·K)
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NOTE: This table present typical literature values for 63/37 alloys.

c) Units conversions: ppm/°C = μ m/(m·K) = in/in/°C × 10⁻⁶ = unit/unit/°C × 10⁻⁶

Solder Alloy Composition

Properties	Value	Properties	Value	
MAIN INGREDIENTS		IMPURITIES a)		
Sn	63.5 to 63.5%	Sb	≤0.20% Max	
Pb	36.5 to 37.5%	Ag	≤0.10% Max	
		Bi	≤0.10% Max	
		In	≤0.10% Max	
Because this product contains lead, it is not RoHS		Cu	≤0.08% Max	
compliant. The following	ig RoHS exemptions are	Au	≤0.05% Max	
applicable 7(b), 15, 24, 31, 33.		As	≤0.03% Max	
		Fe	≤0.02% Max	
		Ni	≤0.01% Max	
		Al	≤0.005% Max	
		Zn	≤0.003% Max	
		Cd	≤0.002% Max	

a) Meets the requirements of J-STD-006

Storage

Protect from direct heat or sunlight.

Cleaning

The flux residue does not need to be removed for typical applications. If removal is desired, a solvent system like the MG~4140 can be used. For best results, warm the cleaning solution to about 40 °C [104 °F].



486x-series

Health and Safety

Please see the 486x (where x = 0, 5, 8) **Safety Data Sheet** (SDS) for more details on transportation, storage, handling and other security guidelines.

HMIS® RATING

HEALTH:	*	2
FLAMMABILITY:		0
PHYSICAL HAZARD:		0
PERSONAL PROTECTION:		

NFPA® 704 CODES



Approximate HMIS and NFPA Risk Ratings Legend:

0 (Low or none); 1 (Slight); 2 (Moderate); 3 (Serious); 4 (Severe)

Health and Safety: Avoid breathing fumes. Wash hands thoroughly after use. Do not ingest.

Packaging and Supporting Products

Cat. No.	Form	Packaging	Net Weight	
4860-18G	Solid wire	Pocket Pack a)	18 g	0.6 oz
4865-227G	Solid wire	Spool	227 g	0.5 lb
4865-454G	Solid wire	Spool	454 g	1.0 lb
4866-227G	Solid wire	Spool	227 g	0.5 lb

a) Box of 25 pocket packs

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486x-series

Technical Support

Contact us regarding any questions, improvement suggestions, or problems with this product. Application notes, instructions, and FAQs are located at www.mgchemicals.com.

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Warranty

M.G. Chemicals Ltd. warranties this product for 12 months from the date of purchase by the end user.
M.G. Chemicals Ltd. makes no claims as to shelf life of this product for the warranty. The liability of M.G.
Chemicals Ltd. whether based on its warranty, contracts, or otherwise shall in no case include incidental or consequential damage.

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